To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies): Weitao Jia

Additional names(s) of conveying party(ies) □ Yes □ No

2. Name and address of receiving party(ies):

Name: PENTRON CLINICAL TECHNOLOGIES

Internal Address:

Street Address: 53 North Plains Industrial Road

City: Wallingford State: CT ZIP: 06492

Additional name(s) & address(es) attached? □ Yes □ No

3. Nature of conveyance:

☒ Assignment □ Merger

☐ Security Agreement □ Change of Name

☐ Other

Execution Date: September 16, 2002

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

10/136,031 April 30, 2002

B. Patent No.(s)

Additional numbers attached? □ Yes □ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Leah M. Reimer

Internal Address: Cantor Colburn LLP

10/07/2002 TB15Z1 00000102 10136031

01 Fc6581 40.00 OP

Street Address: 55 Griffin Road South

City: Bloomfield State: CT ZIP: 06002

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): $40.00

☒ Enclosed - Any excess or insufficiency should be credited or debited to deposit account

☐ Authorized to be charged to deposit account

8. Deposit account number:

06-1130

(Attach duplicate copy of this page if paying by deposit account)


To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Leah M. Reimer

Name of Person Signing

Signature

September 26, 2002

Date

Total number of pages including cover sheet, attachments, and document: 4
ASSIGNMENT

WHEREAS I, Weitao Jia of 73 Liney Hall Lane in the County of New Haven and State of Connecticut; have invented certain new and useful improvements, namely:

DENTAL COMPOSITE MATERIAL AND METHOD OF MANUFACTURE THEREOF

for which I have prepared an application for Letters Patent of the United States;

AND WHEREAS, PENTRON CLINICAL TECHNOLOGIES, LLC, a corporation organized and existing under the laws of the State of Connecticut, having a place of business at 53 North Plains Industrial Road, Wallingford, Connecticut 06492, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and sufficient consideration, the receipt of all of which is hereby acknowledged, I, the said Weitao Jia; have assigned, and transferred, and by these presents do assign and transfer unto the said PENTRON CLINICAL TECHNOLOGIES, LLC., the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said PENTRON CLINICAL TECHNOLOGIES, LLC., assignee of the entire right, title and interest in and to the same, for the sole use and behoof of PENTRON CLINICAL TECHNOLOGIES, LLC., its successors and assigns; and I do hereby agree that the said PENTRON CLINICAL TECHNOLOGIES, LLC., may apply for foreign Letters Patent on said invention and that I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said PENTRON CLINICAL TECHNOLOGIES, LLC. fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.
The undersigned declares that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 9/6/02  Weitao Jia  L.S.